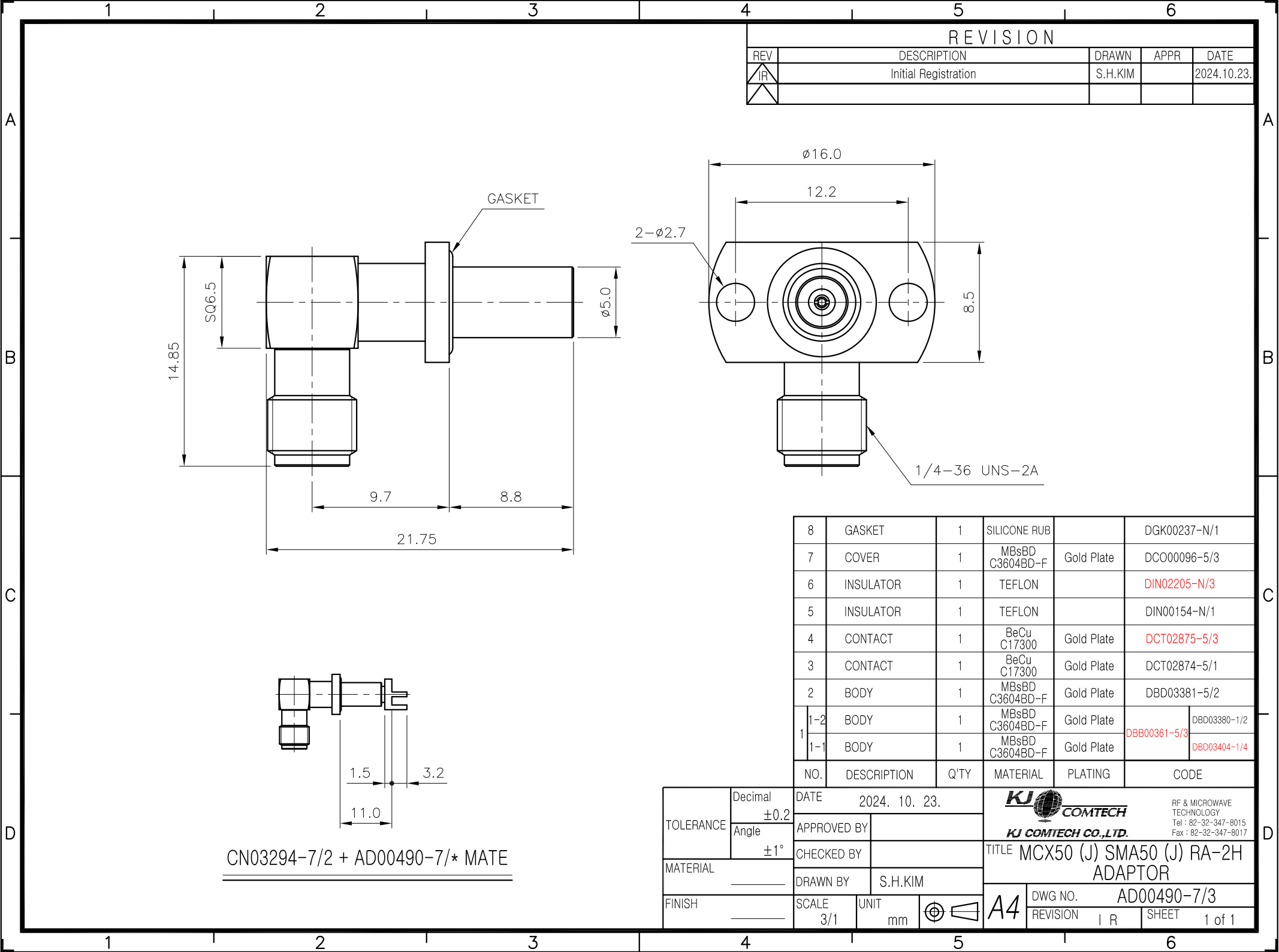




REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.H.KIM		2024.10.23.

8	GASKET	1	SILICONE RUB		DGK00237-N/1	
7	COVER	1	MBsBD C3604BD-F	Gold Plate	DCO00096-5/3	
6	INSULATOR	1	TEFLON		DIN02205-N/3	
5	INSULATOR	1	TEFLON		DIN00154-N/1	
4	CONTACT	1	BeCu C17300	Gold Plate	DCT02875-5/3	
3	CONTACT	1	BeCu C17300	Gold Plate	DCT02874-5/1	
2	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD03381-5/2	
1	1-2 BODY	1	MBsBD C3604BD-F	Gold Plate	DBB00361-5/3	DBD03380-1/2
	1-1 BODY	1	MBsBD C3604BD-F	Gold Plate		DBD03404-1/4
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE	

TOLERANCE	Decimal ±0.2	DATE 2024. 10. 23.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017 KJ COMTECH CO.,LTD.		
	Angle ±1°	APPROVED BY					
MATERIAL	_____	CHECKED BY			TITLE MCX50 (J) SMA50 (J) RA-2H ADAPTOR		
		DRAWN BY S.H.KIM					
FINISH	_____	SCALE 3/1	UNIT mm		A4	DWG NO. AD00490-7/3	
						REVISION I R	SHEET 1 of 1

CN03294-7/2 + AD00490-7/* MATE